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Enhancing the corrosion resistance of Cu/Ni-P/Au electrical contacts by electropolymerized poly(methyl methacrylate)

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- 10 Highlights
- Modifying electrical contacts by electropolymerization of MMA is studied.
 - Ten times increase in the corrosion resistance of electrical contacts is observed.
 - The electrical resistance increased, but remained well below the accepted limit.
 - Cathodic electrodeposition of PMMA effectively sealed the pores of Au top-layer.

Abstract

- 17 Cu/Ni-P/Au multi-layer systems are employed as electrical contacts. The Au top-layer is thin and
- porous. These pores deliver the corrosive media to the under-layer, which induces the corrosion
- by a galvanic coupling mechanism. Therefore, filling these pores is essential to improve the
- 20 lifetime of electronic devices. The pores can be sealed by the electrodeposition of poly(methyl
- 21 methacrylate) that decreased the porosity index (about 97%) and increased the corrosion resistance
- 22 (about 10 times) of electrical contacts after 10 cycles of electropolymerization. A non-uniform
- polymeric film, however, was formed at higher number of polymerization cycles (> 50) that
- 24 decreased the corrosion resistance.
- 25 Keywords: Corrosion, Cathodic electropolymerization, Electrical contacts, Multi-layer thin films, PMMA, Pores

1. Introduction

- 28 Electrical contacts allow exchanging information between a reader and an embedded
- 29 chip. They are extensively applicable in relays, contactors, switches, and circuit
- breakers [1,2]. An electrical contact usually consists of a multilayer Cu/Ni/Au thin
- film stacked to an epoxy tape. Cu is used due to its high electrical conductivity but
- this metal highly suffers from a poor corrosion resistance and oxidation resistance
- that increase its resistivity. Au acts as a protective layer against corrosion. However,
- Cu rapidly diffuses through Au and thus even a thick layer of Au cannot protect it.
- Therefore, Ni or Ni-P are utilized as a diffusion barrier layer. The incorporation of

- P changes the crystalline structure of Ni deposits to an amorphous state. Therefore, 1
- Ni-P films have superior properties due to the lack of crystalline defects (such as 2
- grain boundaries) that serve as preferential sites for diffusion of chemical species 3
- and localized reactions like corrosion. The required thickness of Au is reported to be 4
- drastically reduced when amorphous Ni-P films are used. The Au film is notably 5
- thin due to its high cost; the total thickness of the Ni barrier layer and Au film 6
- remains below 3 µm [3,4]. 7
- However, the porosity of thin films increases with decreasing the thickness. Hence, 8
- thin top Au films in electrical contacts are to some extent porous [4]. The pores act 9
- as channels and deliver corrosive media to the under-layer [2]. The galvanic 10
- coupling inside these pores is responsible for the fast corrosion of the Ni barrier layer 11
- based on the well-known "small anode surface (Ni) large cathode surface (Au)" 12
- phenomenon. After dissolution of Ni films, the subsequent attack of the Cu substrate 13
- occurs [3]. Note that corrosion products are often electrical insulators, they can 14
- terminate the functionality of electrical contacts [5]. Therefore, improving the 15
- corrosion resistance of electrical contacts extends their lifetime and thus has 16
- economic and ecological benefits [6]. It is, however, a huge challenge, since Cu, Ni, 17
- and Au have a large difference in their standard potentials and any modification 18
- should not increase the electrical resistance above a low acceptable value [2]. 19
- Self-assembled monolayers (SAMs) have shown promising results in improving the 20
- corrosion behavior of metals [7–9]. These organic molecules are adsorbed on the 21
- surface and form ordered domains. The interaction between SAMs and the substrate 22
- can be more or less intensive, depending if the molecules possess a head group with 23
- a strong affinity that anchors the molecule to the substrate. SAMs can then modify 24
- the porosity of thin films and thus improve the corrosion resistance [2,6,10]. In the 25
- case of the Cu/Ni/Au multilayer system, if these molecules accumulate at the pores 26
- of the substrate, they can limit the accessibility of the barrier layer to the corrosive 27
- media [11]. Song et al. [6] successfully decreased the porosity index of an Au top-28
- coat using SAMs (AUTRONEXTM Nano 104S). However, the application of SAMs 29
- may increase the electrical resistivity [12]; furthermore, it suffers from bad 30
- reproducibility and is not cost-effective [13]. 31
- Employing polymers is a well-known strategy to enhance the corrosion resistance 32
- [14–17]. Surface anomalies and irregularities, such as pores or surface roughness, 33
- have a different surface energy and thus they can act as polymerization centers 34
- [18,19]. It was found that pores have a strong free-energy minimum. The monomer, 35

therefore, can be adsorbed (partially or completely) inside the pore and polymerize there [20]. As a result, it is theoretically possible to fill the pores of thin Au with polymers. However, most organic coatings suffer from a poor adhesion to their metallic substrate. Poly(methyl methacrylate) or PMMA can be strongly chemisorbed (electrografted) on metals owing to its carbonyl functionality [21,22]. PMMA is a transparent colorless polymer with a low molecular weight showing high corrosion and chemical resistance [23]. Interestingly, it is possible to etch PMMA using UV [24–26] for removing polymer grown outside the pores that partially covers the gold surface and thus enhances the electrical resistivity. As a result, PMMA seems to be a potential candidate to improve the corrosion behavior of electrical contacts.

Electropolymerization is a simple and economical technique that initiates and terminates the chemical reaction through the transfer of electrons [27]. The cathodic electropolymerization of MMA can then be employed to avoid the oxidation of the metallic electrode during the process [22]. Note that this process has been already used to fill titania nanotubes with PMMA for energy storage applications [28–32]. An adequate solvent for electropolymerization should be able to dissolve the monomer and support salt in order to provide sufficient conductivity. In this context, dimethyl sulfoxide (DMSO) is reported to be an excellent solvent for MMA [27].

In this study, the effects of cathodic electropolymerization of MMA (methyl methacrylate) from DMSO on the corrosion behavior of Cu/Ni-P/Au electrical contacts is investigated for the first time. Several techniques including Scanning Electron Microscopy (SEM), Grazing Angle X-Ray Diffraction (Grazing XRD), Electrochemical Impedance Spectroscopy (EIS), Cyclic Polarization (CP), and Salt Spray (SS) tests were implemented to characterize Cu/Ni-P/Au electrical contacts before and after modification with PMMA.

2. Experimental procedure

A DMSO based solution containing 0.1 M KNO₃ (as supporting electrolyte) and 4 vol.% MMA was used to electropolymerize MMA on samples. KNO₃ was added to DMSO and the solution then was stirred for 60 minutes. MMA was added to the solution and the stirring continued for another 30 minutes. Highly pure chemicals (provided by Sigma-Aldrich) were used as received.

- 1 A potentiostat/galvanostat (BioLogic VP300) was employed to perform all
- 2 electrochemical tests in a three-electrode setup containing the sample as the working
- 3 electrode, a Pt plate as the counter electrode, and an Ag/AgCl (KCl saturated)
- 4 reference electrode. Cyclic voltammetry (CV) was used in a cathodic window (-0.5
- 5 to -2.0 V) with a scan rate of 20 mV.s⁻¹ to polymerize MMA at room temperature.
- 6 Different cycle numbers, 5, 10, 15, 25, 50, and 100 cycles, were used to modify Cu/
- 7 Ni-P/Au electrical contacts provided by our industrial partner. The metallic
- 8 multilayer systems have a total thickness of about 35 μm and are deposited on an
- 9 epoxy support. The samples were named after their corresponding cycle number,
- e.g. C0 represents the unmodified sample and C25 is the sample modified by 25
- cycles of MMA polymerization. All the samples were washed with distilled water
- and dried with compressed air after the process.
- A precision scale ($\pm 10^{-4}$ g) was used to determine the mass of polymer by subtracting
- the mass before polymerization from the mass after polymerization. The electrical
- resistivity of samples was measured by a precise Ohm meter ($\pm 1 \text{ m}\Omega$) using the
- classical four-probe measurement.
- 17 The surface morphology and chemical composition of the samples were investigated
- by a scanning electron microscope (model Philips XL 30 ESEM) equipped with an
- 19 Energy Dispersive Spectroscopy (EDS) analyzer. The EDS tests were done at 22
- 20 keV accelerating voltage. A CARL ZEISS/Ultra 55 scanning electron microscope
- 21 was employed for the cross-section images. The crystalline structure of the samples
- was evaluated using a Siemens D5000 diffractometer. Cu K α radiation (λ = 0.15406
- nm) generated at 40 kV and 30 mA was used to obtain XRD patterns with 0.04° step
- size over a 2θ range of $25-70^{\circ}$.
- 25 The corrosion behavior of the samples was investigated by Electrochemical
- Impedance Spectroscopy (EIS) and Cyclic Polarization (CP) tests. The samples were
- immersed in a 3% NaCl solution for 60 minutes. The EIS measurements were carried
- out at Open Circuit Potential (OCP) from 100 kHz to 10 mHz (frequency range) with
- 29 10 mV voltage amplitude (peak-to-peak). The obtained EIS data were analyzed
- using Zview software. The CP experiments were done at a scan rate of 0.5 mV/s
- from -300 mV (vs. OCP) to 500 mV (vs. reference electrode) as the vertex point and
- reversed at 0 mV (vs. reference) as the finishing point. All the tests were repeated
- three times and the results were normalized by the exposed area to the corrosive
- 34 media.

- An Ascott S450 Salt Spray apparatus was employed to do SS tests. The SS tests were
- 2 carried out in accordance with the B 117 ASTM standard. The surface of the samples
- 3 was periodically evaluated during the SS test by an optical microscope
- 4 (ARISTOMET) at 100x magnification. The obtained images were analyzed by
- 5 ImageJ software.

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3. Results and Discussion

• Electropolymerization

Figure 1 presents the CV curves of MMA electropolymerization on the samples in a potential range between -0.5 to -2.0 V vs. Ag/AgCl. The inlay in that figure corresponds to a smaller potential range (-0.5 to -1.5 V). The first cycle (in blue) clearly presents two reductions waves: the first one between -1.2 to -1.8 V where the reduction current is followed by a plateau, the second one below -1.8 V leading to a

steep rise in current.

The increase in the number of cycles, till 25 cycles, induces a rapid decrease of the 15 cathodic current in the both regions I and II (see the inlay, for the region I). This 16 decrease is a direct evidence of electropolymerization: the global amount of polymer 17 grafted during each scan is reduced because of the blocking of cathodic sites by the 18 polymer during the previous scans. This result is in good accordance with pervious 19 works [33–35]. Another way to interpret this current decrease is that the amount of 20 polymer at the surface increases during each cycle of polymerization increasing the 21 electrode resistance [33,34]. Interestingly, after 50 cycles a reverse trend was 22 observed: the cathodic current started again to increase and its value after 100 cycles 23 was even slightly higher than after 10 cycles. The formation of a thick mechanically 24 unstable PMMA layer can lead to the detachment from the electrode and thus 25 exposes the metallic surface [33]. 26

Baute *et al.* [22] investigated the cathodic electropolymerization mechanism of some acrylate monomers (including MMA) form dimethylformamide (DMF). CV curves of the investigated acrylic monomers had 2 cathodic peaks. The first peak at less negative potentials was ascribed to the passivation of surface due to the adsorption of reduced monomer. The second peak was attributed to diffusion control. The first peak (around -1.8 V) was considered the critical potential at which the reaction of electrografting happens. Note that the partial electrografting of MMA occurs even before the first peak. This is in agreement with our results where

- electropolymerization was carried out from -0.5 to -1.5 V (see inlay in Figure 1) and
- 2 a similar decrease in current was observed.
- 3 The effect of electropolymerization cycles on the mass gain of samples is illustrated
- 4 in Figure 2. A strong increase of sample mass can be seen in the first 5 cycles,
- 5 followed by a slow mass increase between C5 to C50 with a quasi-constant slow rate
- of deposition. This result is in good accordance with the small variation of the current
- on CV curves in Figure 1 between C5 to C25. Then a drastic mass increase is
- 8 observed after 50 cycles. This could be simply due to the higher polymerization
- 9 amount at higher polymerization cycles or to a non-uniform polymerization.

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• Chemical characterizations

- The EDS technique was employed to assess the amount of C (and thus the polymer
- amount) as a function of the electropolymerization cycle number (Figure 2). The C
- content increases rapidly till C5 and then almost linearly between 5 to 100 cycles.
- The chemical composition of C0 was 3.3 wt.% Cu, 80.6 wt.% Ni, 5.7 wt.% P, and
- 16 10.4 wt.% Au. The EDS analysis was done at the center of each sample where a
- uniform distribution of current is expected. Therefore, the inconsistency between the
- increase of C content and mass gained after 50 cycles could be due to the non-
- uniform polymerization of MMA especially at the sample edges.
- No polymer should be formed in the absence of a current flow [33]. To prove that, a
- sample was immersed in the electrolyte for 4 hours (that is the equivalent time of
- 22 100 cycles of electropolymerization). No supplementary amount of C was found,
- showing that PMMA was formed due to the applied potential.
- To test the solubility of the formed PMMA in relation to the interaction between the
- polymer and the surface, C10 and C100 were immersed in tetrahydrofuran (THF)
- for 12 hours. The C amounts were 4.8 and 10.3 % for C10 and C100, respectively,
- so quite similar to the first analysis (4.2 and 9.2 % respectively). The insolubility of
- the formed PMMA in THF suggests a strong chemical grafting between Au and the
- electrodeposited polymer [33].
- Figure 3 shows the grazing-incidence XRD patterns of C0 and C100. The observed
- peaks for C0 are related to Au, Ni, and Cu substrate. The strong Cu peak can be
- justified (200 main orientation) by the low thickness (and the partly amorphous
- nature) of the Ni-P barrier layer and Au top-coat, and also the porosity of the Au
- film. The XRD pattern intensity is related to the X-ray penetration depth [36], but

- pores can intensify the penetration of X-rays [37]. The C100 pattern was almost
- 2 similar to C0. However, it showed an increase of the intensity at low diffraction
- angles and a notable decrease in the intensity of the peaks attributed to Cu and Ni.
- 4 Note that the intensity for Au is almost intact. The formation of an amorphous phase,
- 5 here PMMA, on the surface of metals increases the X-ray intensity at low diffraction
- 6 angles [38–40]. The intensity decrease of Cu and Ni can be attributed to the PMMA-
- 7 filled pores.

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• Morphological characterizations

Figure 4 shows optical microscopy images of C0. The micrometer-sized pores are

obviously distributed all over the surface. SEM observations of the surface

morphology of C0 and C100 are presented in Figure 5 (a and b). Both samples

present a similar morphology except that C100 is slightly blurred, possibly due to

the presence of a PMMA insulating deposit. At lower magnification, however, C100

has two distinct features (noted α and β in Figure 5c).

Figure 5c-e shows a non-uniform formation of polymer on the surface. This non-

uniformity of PMMA has been previously reported even at higher concentrations of

monomer [33]. The bright objects (marked as α) were found for all PMMA modified

samples. The bright objects in SE mode are dark spots in the BSE mode, which is

sensitive to the chemical composition (i.e. average atomic number) contrast [41]

21 (Figure 5d). This means they are composed of a material with a low atomic number.

Figure 5e shows one of these objects with a low electron beam power (to have a

better resolution). Point EDS on this object showed 47.7 wt.% C that proves it is in

fact made of PMMA. This object could have been formed in (on) the pores due to

25 the similarities between the black spots in Figure 5d and pores in Figure 4a.

The halo shapes (marked as β in Figure 5c) were observed only for C50 and C100.

27 A point EDS analysis showed 16.3 wt.% C (about 7 % higher than the overall C

content of C100) that suggests a localized polymerization. All the pores could be

29 filled after a certain number of cycles. The polymerization continues on any

available surface since preferential sites (such as pores) are not available, leading to

the formation of halo shapes in C50 and C100.

The cross-section of C100 is shown in Figure 5f. The polymeric features are obvious

on the surface of samples. Therefore, PMMA covered the surface and sealed the

pores. The Au layer with about 100 nm thickness on about 1.5 μm thick Ni-P can be also seen in this figure.

• Electrical resistivity study

The electrical resistance of samples as a function of the electropolymerization cycle is depicted in Figure 2. C100 showed a 91% increase in the electrical resistivity. However, its resistance (40.7 m Ω) is still much lower than the resistivity limit of electrical contacts (300 m Ω) [42]. PMMA, therefore, is a potential candidate to enhance the lifetime of electrical contacts. Moreover, Figure 2 supports the presence of a non-uniform polymer layer because a strong resistivity increase should be observed in the presence of a uniform polymeric film [43–45].

Corrosion resistance study

Figure 6 shows the EIS results obtained for samples with (C5-C100) and without (C0) the presence of PMMA. C0 and C5-C100 had asymmetric and symmetric Bode phase curves (Figure 6b), respectively. This suggests that while C0 has two time-constants, the PMMA modified samples present only one-time constant. The value of Z at low frequencies in the Bode modulus plots (Figure 6c) represents the corrosion resistance of samples. The highest corrosion resistance was observed for 10 cycles of MMA electropolymerization. This maximum can be also observed in the Nyquist plots, where it corresponds to the maximum diameter of the semi-circles (Figure 6a).

The equivalent circuits are represented in Figure 7. Rs is the solution resistance, which has a constant value of 5-6 Ω cm² for all experiments. Constant Phase Elements (CPE) are used to represent the non-ideal capacitive behavior of the samples. The CPE impedance is defined as:

$$Z_{CPE} = \frac{1}{Y_0(i\omega)^n} \tag{1}$$

Y₀ is the constant of admittance, *i* is the imaginary unit, $\omega = 2\pi f$ is the angular frequency, and *n* is the CPE exponent [46]. The *n* factor is sometimes known as the roughness factor since it is often affected by the surface roughness [47]. The polymer area grows after each cycle of polymerization that should lead to a rougher surface. The values of *n* can therefore be used to determine the effect of the polymerization

on the surface roughness. Increasing the roughness decreases the value of n (n=11

corresponds to an ideal parallel-plate capacitance) in agreement with our 2

- experimental data, where n gradually decreased from 0.93 (C0) to 0.83 (C100). 3
- In the equivalent circuits, we assume that the initial sample shows pores where 4
- corrosion can occur. The fast dissolution of Ni in the pores occurs due to the galvanic 5
- coupling between Au (cathode) and Ni (anode). The value of n for CPE_p is 0.526
- suggesting that the corrosion process inside the pores is under mass transport control 7
- [48,49]. CPE_{dl} and R_{ct} represent the double layer capacitance and the charge transfer 8
- resistance of the electrode, respectively. The CPE_{dl} shows typical values for a 9
- metallic electrode ($n \approx 1$ and Q in the μF cm⁻² range). In the PMMA-modified 10
- samples, the pores are filled with the polymer, limiting the corrosion. The proposed 11
- equivalent circuits perfectly fitted the experimental data. The fitted values (analyzed
- 12
- by ZVIEW) are summarized in Table 1 and Table 2. 13

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Assuming that the pores are filled with PMMA after polymerization, the elements 15

- representing the pores are substituted with CPE_{Pol} and R_{Pol} that are related to the 16
- capacitance and resistance behavior of the polymer. The equivalent circuit in Figure 17
- 7b explains the corrosion behavior of the modified samples. This model, however, 18
- can be simplified to a Randles model where: 19

$$20 CPE_t = CPE_{dl} + CPE_{Pol} (2)$$

And 21

$$R_t = \frac{R_{ct} \times R_{Pol}}{R_{ct} + R_{Pol}} \tag{3}$$

- While the metallic surface area decreases during the polymerization, the polymer 23
- surface area increases. Therefore, R_{ct} decreases after each cycle, while R_{Pol} increases. 24
- Pores are confined spaces and an intensified corrosion process occurs inside them. 25
- Filling pores blocks these highly active corrosion sites and thus improves the overall 26
- corrosion resistance [50]. Increasing the cycle number of polymerization, however, 27
- decreases the uniformity of the surface. Therefore, the corrosion resistance 28
- decreases, because a non-uniform protective layer actually promotes the corrosion 29
- by leaving a limited exposed area in the corrosive media [51]. 30

- Figure 8 shows the CP curves of C0, C10, C100, and the Ni-P barrier layer. A
- 2 pseudo-passivation behavior in the anodic branch of the Ni-P barrier was observed,
- as it was previously reported [52]. C0 showed the same behavior.
- 4 The Tafel extrapolation method was used to obtain the corrosion current density
- 5 (i_{corr}), the corrosion potential (E_{corr}), and the anodic (β_a) and cathodic (β_c) slopes from
- 6 CP tests. These data are used to calculate the polarization resistance (R_P) by the
- 7 Stern-Geary equation [53]. The corresponding data are summarized in Table 3.

$$8 R_P = \frac{\beta_a \beta_c}{2.303(\beta_a + \beta_c)i_{corr}} (4)$$

- 9 The comparison of β_a for C0 and the Ni-P barrier layer (58 vs. 137 mV.dec⁻¹,
- respectively) suggests a fast anodic reaction for C0. This anodic reaction could be
- attributed to the fast dissolution of the Ni-P underlayer due to the galvanic corrosion
- occurring inside the pores. The passivation behavior was not observed for PMMA
- modified samples, possibly due to the filled pores.
- Polarization resistance values were in good agreement with those obtained from EIS
- tests and C10 revealed the highest resistance value. PMMA-covered samples had a
- nobler corrosion potential than C0. The more positive corrosion potential can be
- interpreted as the reduction of the corrosion inclination [54]. Decreasing the porosity
- shifts the corrosion potential to less cathodic values and decreases the corrosion
- current density [55]. Therefore, PMMA modified samples should have a lower
- 20 porosity content. The porosity index (P.I) of surface coatings can be estimated by
- 21 inserting the corrosion potential difference between the coated sample and the
- substrate (ΔE), the substrate polarization resistance (R_{ps}), the substrate anodic slope
- 23 (β_a) , and the coating polarization resistance (R_p) Eq. 5 [56].

$$P.I = \frac{R_{ps}}{R_p} \times 10^{-\left(\frac{\Delta E}{\beta_a}\right)} \tag{5}$$

- 25 P.I values for C0 and C10 were 0.0269 and 0.0008, respectively, showing a 97%
- decrease in the porosity of the Au top-layer after 10 cycles of electropolymerization
- of MMA. A positive hysteresis loop was observed for all samples indicating that the
- occurrence of localized corrosion is inevitable. Au is generally known to be
- chemically inert. However, it can be corroded under anodic polarization and in the
- presence of chloride or bromide ions (due to the formation of Au complexes) [57].
- Moreover, random pits can be always formed on the surface of metals due to their
- autocatalytic nature [58]. The corrosion could be even more severe for Au thin films.

Figure 9 shows the surface of samples after CP tests. The surface of C0 was severely damaged and the Cu substrate can be easily seen. The corrosion on the PMMA modified samples was restricted to the formation of green spots, and C10 had the lowest number of spots. These green corrosion products are reported to be clinoatacamite (Cu₂(OH)₃Cl) [4]. Therefore, the amount of Cu, Cl, and O after corrosion tests can demonstrate the corrosion progress (Figure 10). According to this figure, C10 presents the lowest content of Cu, O, and Cl and therefore the highest corrosion resistance. The content trends of Cu, Cl, and O (as a function of the polymerization cycle) are in good agreement with the respective polarization resistance and charge transfer resistance values.

The salt spray test, which is one of the most employed techniques to determine the atmospheric corrosion behavior of materials, was used to evaluate C0 and C10 in a long-time exposure (10 days) to corrosive media. However, the mass loss (gain) was reported to be negligible for electrical contacts during the salt spray test. As a result, weight measurement is not a suitable technique to estimate the corrosion of electrical contacts [3]. The pit size was therefore traced and compared for C0 and C10 (Figure 11). C0 showed a fast increase in the pit size after 48 hours and large pits were obvious after 240 hours. On the other hand, C10 showed a slow growth of pit area with a surface morphology almost unchanged after 240 hours. However, new pits were formed pointing out that the pitting corrosion is inevitable. EIS was used to verify the long-term corrosion behavior of the samples. As it was mentioned above, the |Z| values at low frequencies (i.e. 10 mHz) can be used to determine the corrosion resistance. Figure 12 shows the Bode Z plots of C0 and C10 during 240 hours of immersion in 3% NaC1. While the corrosion resistance of C0 gradually decreased (from 80 to 12 k Ω .cm²), C10 presented a stable resistance value during 10 days.

In conclusion, all corrosion tests, including EIS and salt spray tests, showed that the corrosion resistance of electrical contacts can be significantly improved by depositing PMMA. The best results were obtained using 10 electropolymerization cycles of MMA monomer. The electropolymerization of MMA is a valuable post-treatment method to enhance the corrosion resistance of electrical contacts.

4. Conclusions

The corrosion behavior of Cu/Ni-P/Au electrical contacts can be effectively modified by cathodic electrodeposition of PMMA. A strongly electrografted PMMA is formed on top of the electrical contacts and thus seals the pores of the Au thin top-

- layer. The polymerization preferentially starts at surface defects like pits and pores. 1
- Continuing the polymerization when there is no preferential site available leads to a 2
- non-uniform growth of PMMA. Therefore, a maximum of corrosion resistance as a 3
- function of polymerization cycles is expected (10 cycles in this study). A further 4
- increase of the number of polymerization cycles leads to the formation of a non-5
- uniform polymeric film. The sealed pores disconnect the Ni-P barrier layer from the 6
- corrosive media and thus improve the corrosion resistance by eliminating the 7
- galvanic coupling between the Au top-coat (cathode) and the Ni-P under-layer 8
- (anode). The PMMA modified electrical contacts have a high stability against 9
- corrosion at high exposure times (10 days). Although PMMA slightly increases the 10
- sample resistance, the resistance values are notably lower than the accepted limit for 11
- electrical contacts. As a result, electrodeposition of PMMA is an economical 12
- solution to improve the lifetime of electrical contacts. Moreover, this technique
- 13
- could be applicable to compensate the negative effects of porosity in other systems 14
- as well. The fretting corrosion of electrical contacts, due to the lubricating nature of 15
- polymers, may also be improved; this point will be subject of further investigations. 16

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Tables

Table 1. Fitted values of C0 using the EC presented in Figure 7a $\,$

Rs	CPE _{dl}		R _{ct}	CPE _p		$R_{\mathfrak{p}}$
$(\Omega.\text{cm}^2)$	Υ° (μF.cm ⁻² .s ⁿ⁻¹)	n	$(k\Omega.cm^2)$	Υ° (μF.cm ⁻² .s ⁿ⁻¹)	n	$(k\Omega.cm^2)$
5.1±0.2	2.0±0.5	0.93±0.01	96±5	8.8±0.5	0.52±0.06	6±2

Table 2. Fitted values of PMMA modified samples using the EC presented in Figure 7b

Sample	$R_s (\Omega.cm^2)$	СР	R_{t}		
	Ks (S2.CIII)	Υ° (μF.cm ⁻² .s ⁿ⁻¹)	n	$(k\Omega.cm^2)$	
C5	5.3 ± 0.8	24 ± 7	0.88 ± 0.02	150 ± 23	
C10	6.0 ± 1.7	16 ± 4	0.87 ± 0.03	274 ± 24	
C15	5.6 ± 0.1	21 ± 3	0.87 ± 0.02	161 ± 34	
C25	5.9 ± 1.5	20 ± 4	0.86 ± 0.03	88± 15	
C50	5.7 ± 0.9	39 ± 16	0.86 ± 0.03	25± 6	
C100	6.0 ± 1.0	32 ± 6	0.83 ± 0.04	13± 5	

Table~3.~Corrosion~current~density,~corrosion~potential,~anodic~and~cathodic~slopes,~and~polarization~resistance~of~Ni-P~barrier~layer~and~C0-C100

Sample	icorr	E _{corr} (mV)	Average Tafel slope (mV. dec ⁻¹)		R_p
	(μA.cm ⁻²)	vs. Ag/AgCl	β_a	βο	$(k\Omega.cm^2)$
Ni-P barrier layer	6.68 ± 0.78	-202 ± 7	137 ± 10	147 ± 14	5 ± 1
C0	0.50 ± 0.10	-110 ± 7	58 ± 5	196 ± 13	40 ± 8
C5	0.18 ± 0.02	-14 ± 23	149 ± 26	99 ± 5	148 ± 24
C10	0.08 ± 0.01	-36 ± 3	151 ± 9	102 ± 21	339 ± 92
C15	0.15 ± 0.04	4 ± 11	114 ± 39	114 ± 3	168± 28
C25	0.24 ± 0.10	-16 ± 20	128 ± 31	108 ± 4	116 ± 35
C50	1.93 ± 0.73	-33 ± 13	187 ± 40	135 ± 4	20 ± 8
C100	2.68 ± 1.92	-75 ± 13	199 ± 76	158 ± 42	17±8

Figures

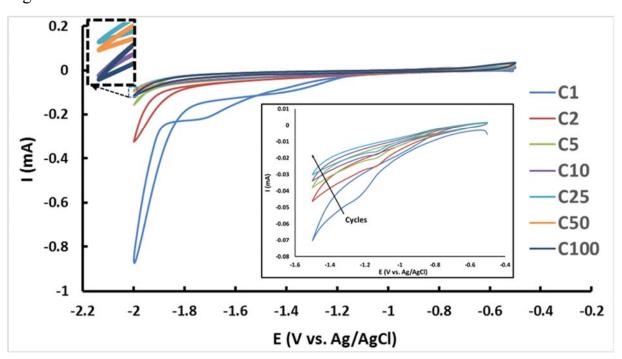


Figure 1. CV curves of cathodic electropolymerization of MMA on Cu/Ni-P/Au electrical contacts from 0.1 M KNO3 DMSO solution with a scan rate of $20~\text{mV.s}^{-1}$.

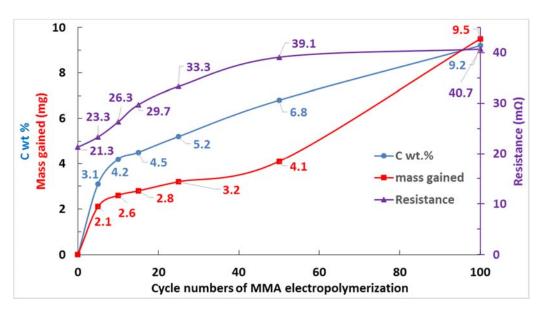


Figure 2. Mass gain, C content, and resistance as a function of electropolymerization cycle number.

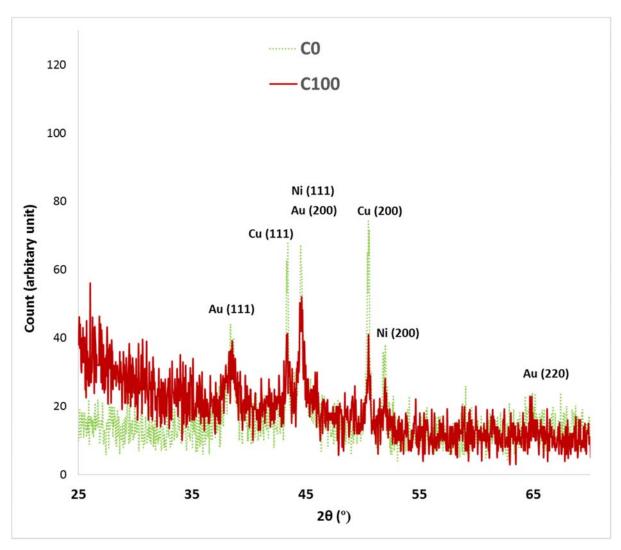


Figure 3. Grazing incidence XRD patterns of C0 and C100.

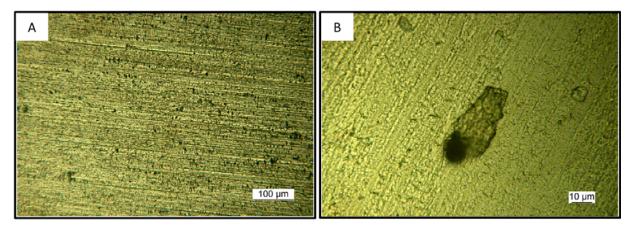


Figure 4. Optical micrograph of C0 at low (a) and high (b) magnifications.

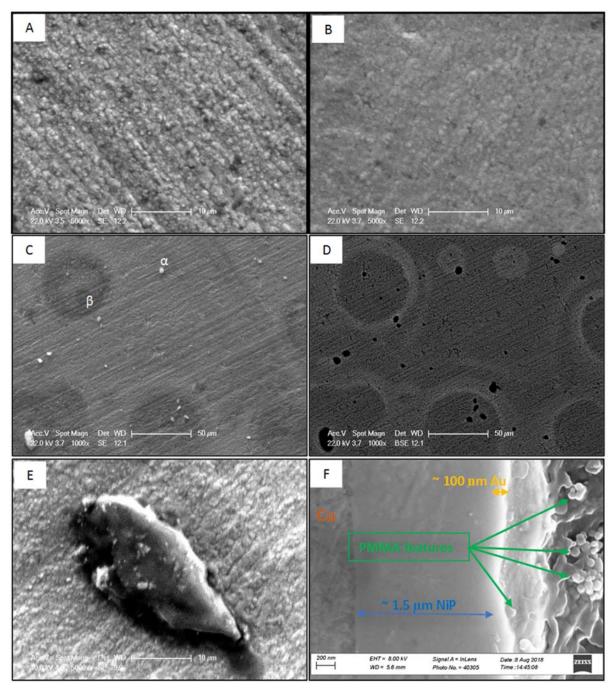


Figure 5. (a) SE SEM image of C0, (b) SE SEM image of C100, (c) SE SEM image of C100, (d) BSE SEM image of C100, (e) SE SEM image of C100 (10kV electron beam power), and (f) cross-section BSE SEM image of C100.

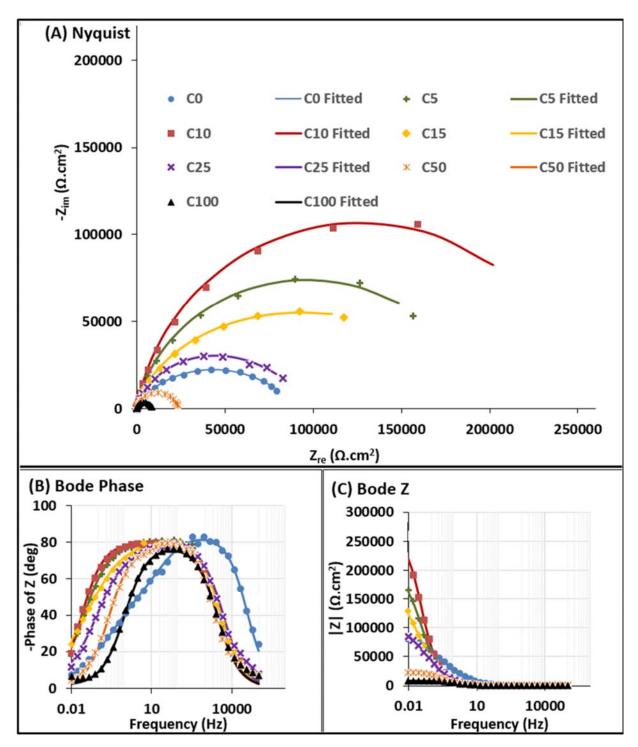


Figure 6. (a) Nyquist, (b) Bode Phase, and (c) Bode modulus curves of C0-C100 after one hour immersion in 3% NaCl solution.

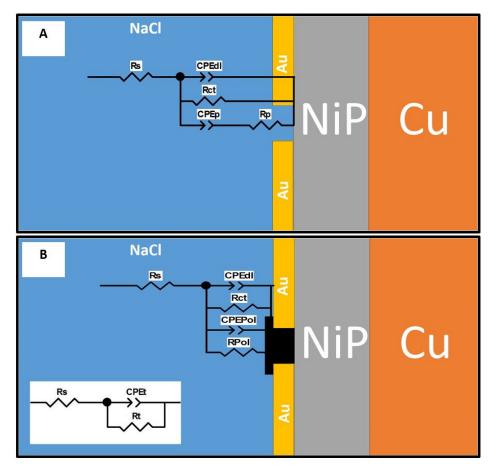


Figure 7. Proposed equivalent circuits to fit the EIS data of (a) C0, and (b) PMMA modified samples (C5-C100).

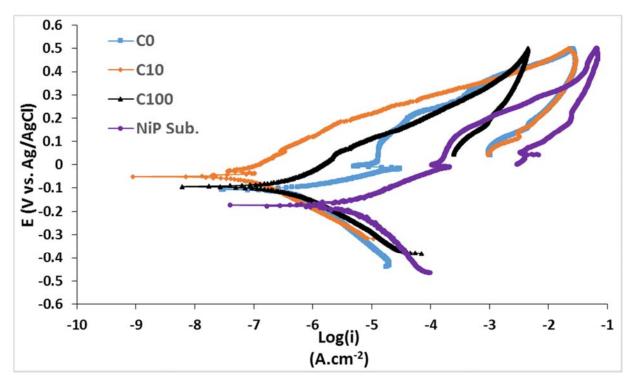


Figure 8. CP curves of C0, C10, C100, and the Ni-P substrate after one hour immersion in 3% NaCl solution.

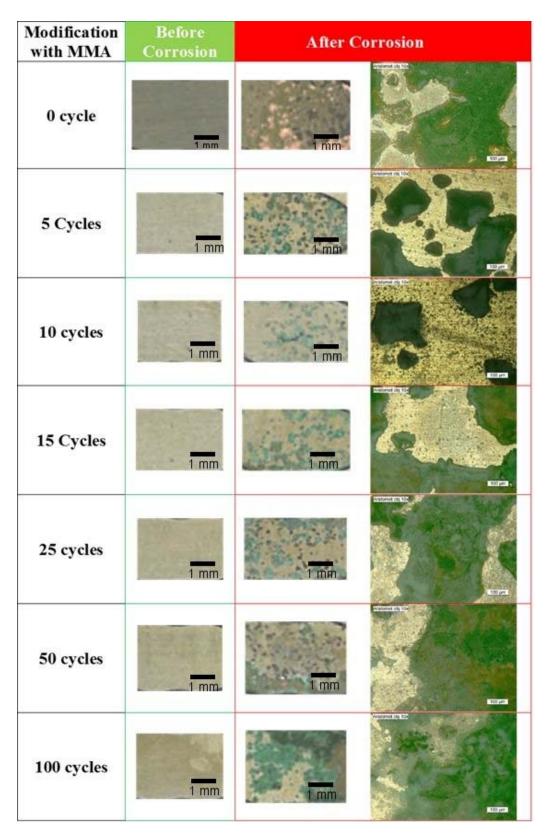


Figure 9. Surface of the samples before and after electrochemical corrosion tests.

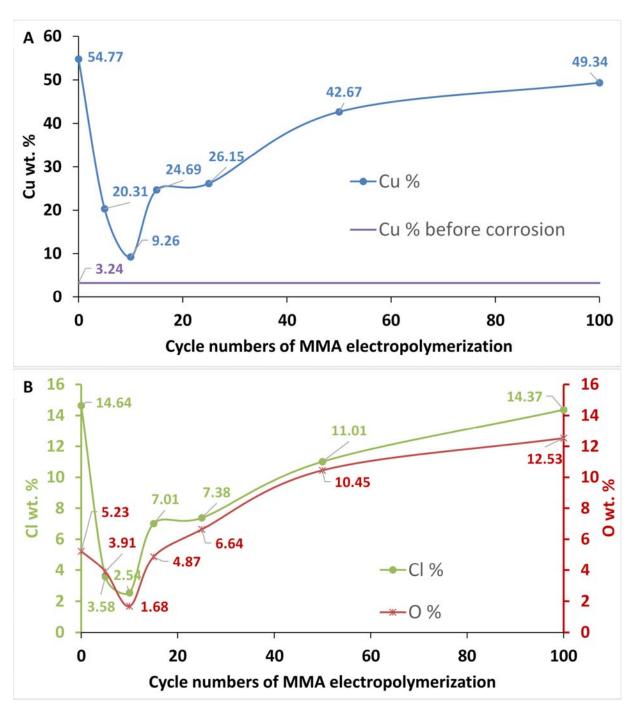


Figure 10. (a) Cu wt.%, and (b) Cl wt.% and O wt.% of samples after the corrosion tests as a function of the electropolymerization cycle number.

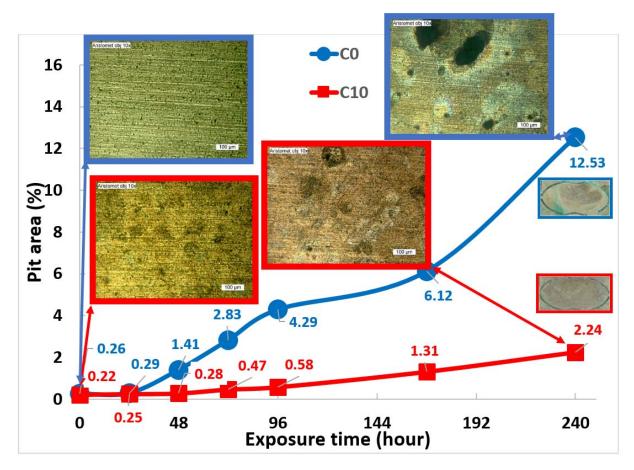


Figure 11. Pit area of C0 and C10 during 240 hours of salt spray test.

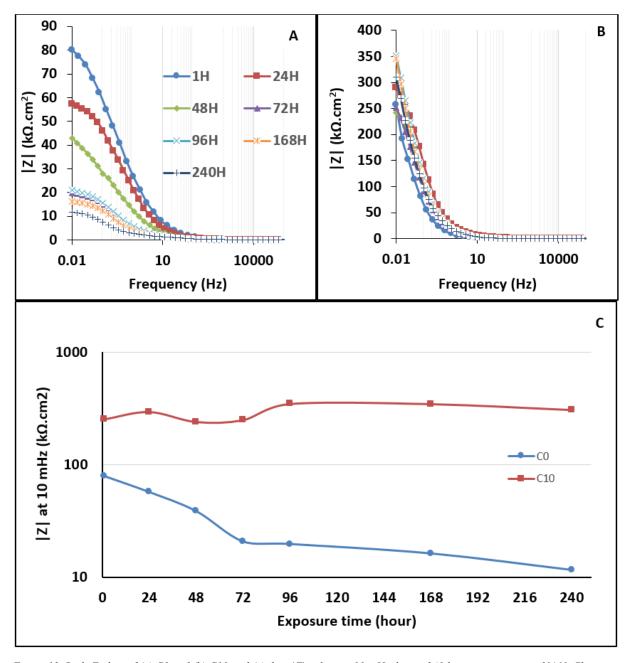


Figure 12. Bode Z plots of (a) C0 and (b) C10 and (c) their |Z| values at 10 mHz during 240 hours immersion in 3% NaCl solution.